

# $0.5\ \Omega$ CMOS 1.65 V to 3.6 V Dual SPDT/2:1 Mux in Mini LFCSP Package

# **ADG824**

#### **FEATURES**

0.5  $\Omega$  typical on resistance 0.7  $\Omega$  maximum on resistance at 85°C 1.65 V to 3.6 V operation High current carrying capability: 300 mA continuous Rail-to-rail switching operation Fast switching times <20 ns Typical power consumption (<0.1  $\mu$ W) 1.3 mm  $\times$  1.6 mm mini LFCSP package

#### **APPLICATIONS**

Cellular phones PDAs MP3 players Power routing Battery-powered systems PCMCIA cards Modems Audio and video signal routing Communication systems

#### **GENERAL DESCRIPTION**

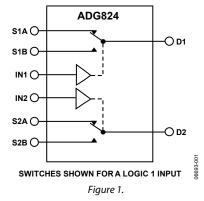
The ADG824 is a low voltage CMOS device containing two independently selectable single-pole, double throw (SPDT) switches. This device offers ultralow on resistance of less than 0.7  $\Omega$  over the full temperature range. The ADG824 is fully specified for 3.3 V, 2.5 V, and 1.8 V supply operation.

Each switch conducts equally well in both directions when on, and has an input signal range that extends to the supplies. The ADG824 exhibits break-before-make switching action.

The low on resistance of the ADG824 makes this device ideal for audio switching. In addition, a data rate of 180 Mbps makes the device suitable for USB low speed (1.5 Mbps) and full speed (12 Mbps) data switching.

The ADG824 is available in a 1.3 mm  $\times$  1.6 mm, 10-lead mini LFCSP package.

#### FUNCTIONAL BLOCK DIAGRAM



#### **PRODUCT HIGHLIGHTS**

- 1. <0.7  $\Omega$  over the full temperature range of -40°C to +85°C.
- 2. Single 1.65 V to 3.6 V operation.
- 3. 1.8 V logic compatible.
- 4. High current carrying capability (300 mA continuous current at 3.3 V).
- 5. Low THD + N (0.06% typical).
- 6. 1.3 mm × 1.6 mm mini LFCSP package.

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#### **REVISION HISTORY**

4/08—Revision 0: Initial Version

# **SPECIFICATIONS**

 $V_{\rm DD}$  = 2.7 V to 3.6 V, GND = 0 V, unless otherwise noted.

#### Table 1.

Parameter	+25°C	-40°C to +85°C	Unit	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 to V <sub>DD</sub>	V	
On Resistance, Ron	0.5		Ωtyp	$V_{DD} = 2.7 \text{ V}, \text{ V}_{\text{S}} = 0 \text{ V} \text{ to } \text{ V}_{DD}, \text{ I}_{\text{DS}} = 100 \text{ mA}; \text{ see Figure 19}$
	0.65	0.7	Ωmax	
On Resistance Match Between	0.003		Ωtyp	$V_{DD} = 2.7 \text{ V}, V_{S} = 0.65 \text{ V}, I_{DS} = 100 \text{ mA}$
Channels, ΔR <sub>ON</sub>		0.01	Ωmax	
On Resistance Flatness, R <sub>FLAT (ON)</sub>	0.13		Ωtyp	$V_{DD} = 2.7 V$ , $V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = 100 mA$
		0.2	Ωmax	
LEAKAGE CURRENTS				$V_{DD} = 3.6 V$
Source Off Leakage, Is (Off)	±0.2		nA typ	$V_{s} = 0.6 V/3.3 V, V_{D} = 3.3 V/0.6 V$ ; see Figure 20
Channel On Leakage, I <sub>D</sub> , I <sub>s</sub> (On)	±0.2		nA typ	$V_{s} = V_{D} = 0.6 V \text{ or } 3.3 V$ ; see Figure 21
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		1.3	V min	
Input Low Voltage, VINL		0.8	V max	
Input Current				
linl or linh	0.005		μA typ	$V_{IN} = V_{INL} \text{ or } V_{INH}$
		±0.1	µA max	$V_{IN} = V_{INL} \text{ or } V_{INH}$
Digital Input Capacitance, C <sub>IN</sub>	2.7		pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>				
t <sub>on</sub>	7		ns typ	$R_L = 50 \Omega, C_L = 35 pF$
	9.5	10.8	ns max	$V_s = 2 V/0 V$ ; see Figure 22
toff	6		ns typ	$R_L = 50 \Omega, C_L = 35 pF$
	7.7	8.6	ns max	$V_s = 2 V$ ; see Figure 22
Break-Before-Make Time Delay, tBBM	3.5		ns typ	$R_L = 50 \Omega, C_L = 35 pF$
		2	ns min	$V_{S1} = V_{S2} = 2 V$ ; see Figure 23
Charge Injection, Q <sub>INJ</sub>	27		pC typ	$V_s = 1.5 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 24
Off Isolation	-71		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 25
Channel-to-Channel Crosstalk	-90		dB typ	S1A to S2A/S1B to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 \text{ kHz}$ ; see Figure 26
	-67		dB typ	S1A to S1B/S2A to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 \text{ kHz}$ ; see Figure 27
Total Harmonic Distortion, THD + N	0.06		%	$R_L = 33 \Omega$ , f = 20 Hz to 20 kHz, V <sub>s</sub> = 2 V p-p
Insertion Loss	-0.05		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
–3 dB Bandwidth	90		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
C <sub>s</sub> (Off)	25		pF typ	
C <sub>D</sub> , C <sub>s</sub> (On)	58		pF typ	
POWER REQUIREMENTS				$V_{DD} = 3.6 V$
	0.003		μA typ	Digital inputs = 0 V or 3.6 V
		1	µA max	

<sup>1</sup> Guaranteed by design; not subject to production test.

 $V_{\text{DD}}$  = 2.5 V  $\pm$  0.2 V, GND = 0 V, unless otherwise noted.

#### Table 2.

Parameter	+25°C	-40°C to +85°C	Unit	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 to V <sub>DD</sub>	V	
On Resistance, Ron	0.65		Ω typ	$V_{DD} = 2.3 V$ , $V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = 100 m$ A; see Figure 19
	0.78	0.83	Ωmax	
On Resistance Match Between	0.005		Ω typ	$V_{DD} = 2.3 V$ , $V_{S} = 0.7 V$ , $I_{DS} = 100 mA$
Channels, ∆R <sub>on</sub>		0.01	Ωmax	
On Resistance Flatness, R <sub>FLAT (ON)</sub>	0.2		Ω typ	$V_{DD} = 2.3 V$ , $V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = 100 mA$
		0.3	Ωmax	
LEAKAGE CURRENTS				$V_{DD} = 2.7 V$
Source Off Leakage, Is (Off)	±0.2		nA typ	$V_{s} = 0.6 V/2.4 V$ , $V_{D} = 2.4 V/0.6 V$ ; see Figure 20
Channel On Leakage, I <sub>D</sub> , I <sub>S</sub> (On)	±0.2		nA typ	$V_{s} = V_{D} = 0.6 V \text{ or } 2.4 V$ ; see Figure 21
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		1.3	V min	
Input Low Voltage, V <sub>INL</sub>		0.7	V max	
Input Current				
Iinl or Iinh	0.005		μA typ	$V_{IN} = V_{INL} \text{ or } V_{INH}$
		±0.1	μA max	$V_{IN} = V_{INL} \text{ or } V_{INH}$
Digital Input Capacitance, C <sub>IN</sub>	2.7		pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>				
t <sub>on</sub>	9		ns typ	$R_L = 50 \Omega, C_L = 35 pF$
	11.5	12.4	ns max	$V_s = 1.5 V/0 V$ ; see Figure 22
t <sub>off</sub>	6		ns typ	$R_L = 50 \Omega, C_L = 35 pF$
	7.4	8	ns max	V <sub>s</sub> = 1.5 V; see Figure 22
Break-Before-Make Time Delay, t <sub>BBM</sub>	5		ns typ	$R_L = 50 \Omega$ , $C_L = 35 pF$
		3	ns min	$V_{S1} = V_{S2} = 1.5 V$ ; see Figure 23
Charge Injection, Q <sub>INJ</sub>	21		pC typ	$V_s = 1.5 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 24
Off Isolation	-71		dB typ	$R_L$ = 50 $\Omega,$ $C_L$ = 5 pF, f = 100 kHz; see Figure 25
Channel-to-Channel Crosstalk	-90		dB typ	S1A to S2A/S1B to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 26
	-71		dB typ	S1A to S1B/S2A to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 \text{ kHz}$ ; see Figure 27
Total Harmonic Distortion, THD + N	0.1		%	$R_L = 33 \Omega$ , f = 20 Hz to 20 kHz, V <sub>s</sub> = 1.5 V p-p
Insertion Loss	-0.065		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
–3 dB Bandwidth	90		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
Cs (Off)	25		pF typ	
C <sub>D</sub> , C <sub>s</sub> (On)	60		pF typ	
POWER REQUIREMENTS				$V_{DD} = 2.7 V$
lod	0.003		μA typ	Digital inputs = 0 V or 2.7 V
		1	µA max	

<sup>1</sup> Guaranteed by design; not subject to production test.

 $V_{\text{DD}}$  = 1.65 V to 1.95 V, GND = 0 V, unless otherwise noted.

Table	3.
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Parameter	+25°C	-40°C to +85°C	Unit	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 to V <sub>DD</sub>	V	
On Resistance, Ron	1.3		Ω typ	$V_{DD} = 1.8 V$ , $V_S = 0 V$ to $V_{DD}$ , $I_{DS} = 100 m$ A; see Figure 19
	1.7	2.1	Ωmax	
	2.5	3	Ωmax	$V_{DD} = 1.65 \text{ V}, V_S = 0 \text{ V}$ to $V_{DD}, I_{DS} = 100 \text{ mA}$ ; see Figure 19
On Resistance Match Between	0.01		Ωtyp	$V_{DD} = 1.65 \text{ V}, V_S = 0.7 \text{ V}, I_{DS} = 100 \text{ mA}$
Channels, ΔR <sub>ON</sub>				
LEAKAGE CURRENTS				$V_{\text{DD}} = 1.95 \text{ V}$
Source Off Leakage, I <sub>s</sub> (Off)	±0.2		nA typ	$V_{S} = 0.6 \text{ V}/1.65 \text{ V}, V_{D} = 1.65 \text{ V}/0.6 \text{ V}$ ; see Figure 20
Channel On Leakage, I <sub>D</sub> , I <sub>S</sub> (On)	±0.2		nA typ	$V_S = V_D = 0.6 V$ or 1.65 V; see Figure 21
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		0.65 V <sub>DD</sub>	V min	
Input Low Voltage, VINL		0.35 V <sub>DD</sub>	V max	
Input Current				
Inl or Inh	0.005		μA typ	$V_{IN} = V_{INL} \text{ or } V_{INH}$
		±0.1	μA max	$V_{IN} = V_{INL} \text{ or } V_{INH}$
Digital Input Capacitance, C <sub>IN</sub>	2.7		pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>				
t <sub>on</sub>	13		ns typ	$R_L = 50 \Omega$ , $C_L = 35 pF$
	18.6	19.3	ns max	$V_s = 1.2 \text{ V/O V}$ ; see Figure 22
toff	7		ns typ	$R_L = 50 \Omega$ , $C_L = 35 pF$
	9.8	10.2	ns max	$V_s = 1.2 V$ ; see Figure 22
Break-Before-Make Time Delay, tBBM	7.5		ns typ	$R_L = 50 \Omega$ , $C_L = 35 pF$
		5	ns min	$V_{s1} = V_{s2} = 1.2 V$ ; see Figure 23
Charge Injection, Q <sub>INJ</sub>	15		pC typ	$V_s = 1 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 24
Off Isolation	-71		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 25
Channel-to-Channel Crosstalk	-90		dB typ	S1A to S2A/S1B to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 \text{ kHz}$ ; see Figure 26
	-71		dB typ	S1A to S1B/S2A to S2B, $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 \text{ kHz}$ ; see Figure 27
Total Harmonic Distortion, THD + N	0.4		%	$R_L = 33 \Omega$ , f = 20 Hz to 20 kHz, V <sub>s</sub> = 1.2 V p-p
Insertion Loss	-0.1		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
–3 dB Bandwidth	90		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 28
C <sub>s</sub> (Off)	26		pF typ	
C <sub>D</sub> , C <sub>s</sub> (On)	61		pF typ	
POWER REQUIREMENTS		1		$V_{DD} = 1.95 V$
IDD	0.003		μA typ	Digital inputs = 0 V or 1.95 V
		1	µA max	

<sup>1</sup> Guaranteed by design; not subject to production test.

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}C$ , unless otherwise noted.

#### Table 4.

Parameter	Rating
V <sub>DD</sub> to GND	–0.3 V to +4.6 V
Analog Inputs <sup>1</sup>	-0.3 V to V <sub>DD</sub> + 0.3 V
Digital Inputs <sup>1</sup>	–0.3 V to +4.6 V or 10 mA, whichever occurs first
Peak Current, Sx or Dx Pins	Pulsed at 1 ms, 10% duty cycle max
3.3 V Operation	500 mA
2.5 V Operation	460 mA
1.8 V Operation	420 mA
Continuous Current, Sx or Dx Pins	
3.3 V Operation	300 mA
2.5 V Operation	275 mA
1.8 V Operation	250 mA
Operating Temperature Range	–40°C to +85°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
Mini LFCSP Package	
θ <sub>JA</sub> Thermal Impedance (4-Layer Board)	131.6°C/W
Reflow Soldering (Pb-Free)	
Peak Temperature	260°C
Time at Peak Temperature	10 sec to 40 sec

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating may be applied at any one time.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

<sup>1</sup> Overvoltages at the INx, Sx, or Dx pins are clamped by internal diodes. Current should be limited to the maximum ratings given.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

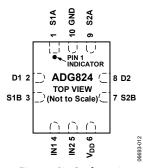


Figure 2. Pin Configuration

Pin No.	Mnemonic	Description	
1	S1A	Source Terminal. This pin can be an input or an output.	
2	D1	Drain Terminal. This pin can be an input or an output.	
3	S1B	Source Terminal. This pin can be an input or an output.	
4	IN1	Logic Control Input. This pin controls Switch S1A and Switch S1B to D1.	
5	IN2	Logic Control Input. This pin controls Switch S2A and Switch S2B to D2.	
6	V <sub>DD</sub>	Most Positive Power Supply Potential.	
7	S2B	Source Terminal. This pin can be an input or an output.	
8	D2	Drain Terminal. This pin can be an input or an output.	
9	S2A	Source Terminal. This pin can be an input or an output.	
10	GND	Ground (0 V) Reference.	

#### Table 6. ADG824 Truth Table

Logic (IN1/IN2)	Switch A (S1A or S2A)	Switch B (S1B or S2B)
0	Off	On
1	On	Off

# **TYPICAL PERFORMANCE CHARACTERISTICS**

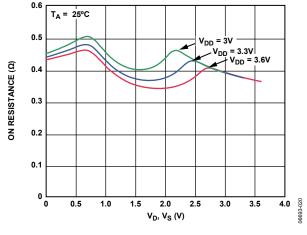


Figure 3. On Resistance vs. V<sub>D</sub> (V<sub>s</sub>), V<sub>DD</sub> = 3.3 V  $\pm$  0.3 V

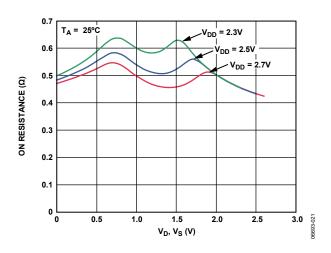
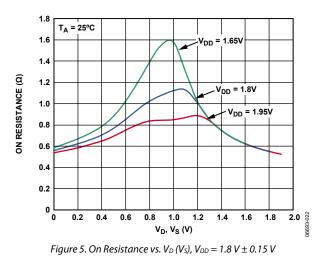


Figure 4. On Resistance vs.  $V_D$  ( $V_S$ ),  $V_{DD} = 2.5 V \pm 0.2 V$ 



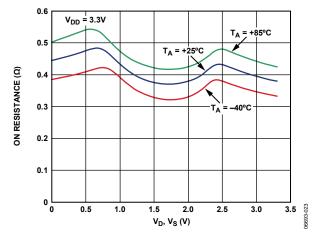


Figure 6. On Resistance vs.  $V_D$  (V<sub>S</sub>) for Different Temperatures,  $V_{DD} = 3.3 V$ 

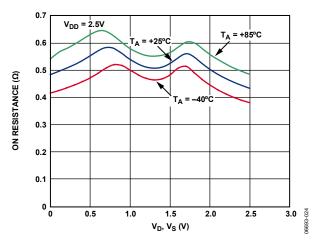
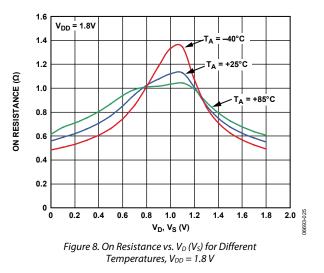
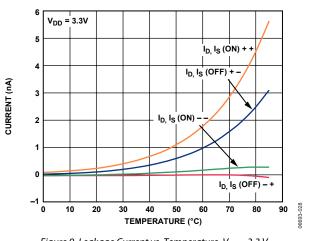
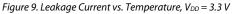
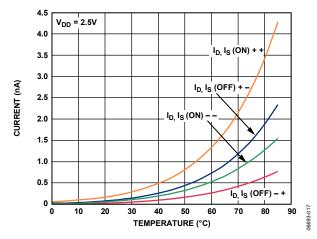


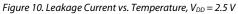
Figure 7. On Resistance vs.  $V_D$  (Vs) for Different Temperatures,  $V_{DD} = 2.5 V$ 











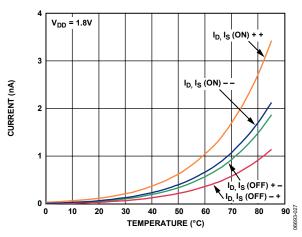
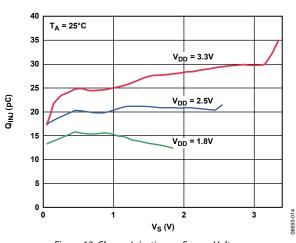
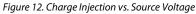
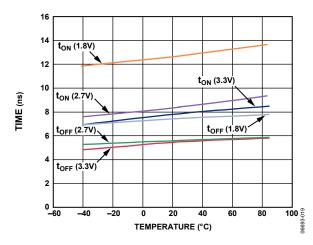


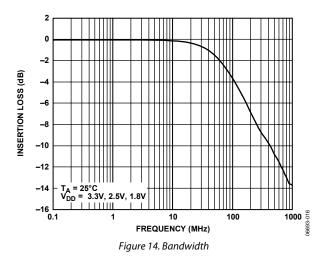
Figure 11. Leakage Current vs. Temperature,  $V_{DD} = 1.8 V$ 



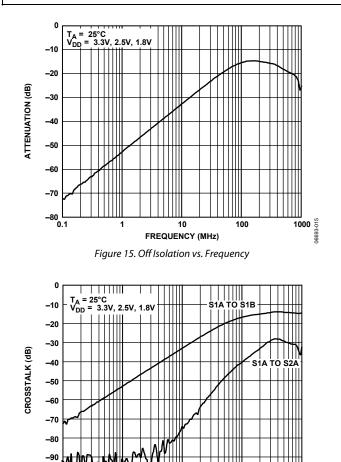








-100 L. 0.1



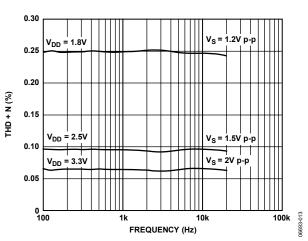
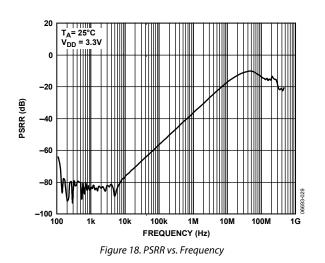


Figure 17. Total Harmonic Distortion + Noise vs. Frequency



1000 <sup>810-66990</sup>

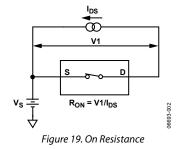
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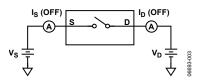
10

FREQUENCY (MHz)

Figure 16. Crosstalk vs. Frequency

# **TEST CIRCUITS**





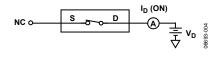


Figure 20. Off Leakage

Figure 21. On Leakage

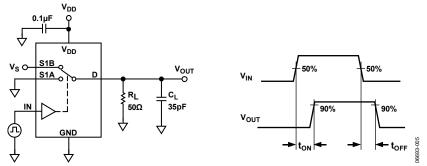
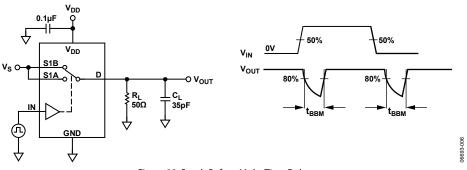


Figure 22. Switching Times, ton, toFF





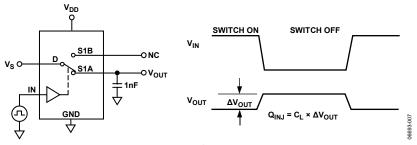
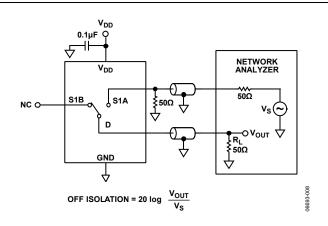
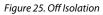


Figure 24. Charge Injection





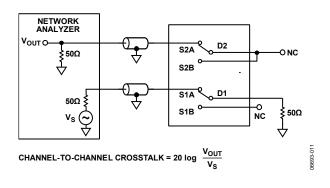


Figure 26. Channel-to-Channel Crosstalk (S1A to S2A/S1B to S2B)

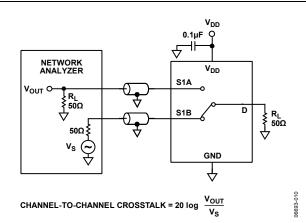


Figure 27. Channel-to-Channel Crosstalk (S1A to S1B/S2A to S2B)

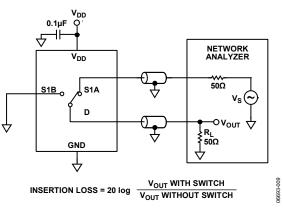


Figure 28. Bandwidth

# TERMINOLOGY

#### Idd

Positive supply current.

#### $V_D$ (Vs)

Analog voltage on Terminal D and Terminal S.

#### Ron

Ohmic resistance between Terminal D and Terminal S.

#### R<sub>FLAT</sub> (On)

The difference between the maximum and minimum values of on resistance as measured on the switch.

#### $\Delta R_{ON}$

On resistance match between any two channels.

#### Is (Off)

Source leakage current with the switch off.

#### I<sub>D</sub> (Off)

Drain leakage current with the switch off.

#### ID, Is (On)

Channel leakage current with the switch on.

#### $\mathbf{V}_{\mathrm{INL}}$

Maximum input voltage for Logic 0.

#### VINH

Minimum input voltage for Logic 1.

#### $I_{INL}$ ( $I_{INH}$ )

Input current of the digital input.

#### Cs (Off)

Off switch source capacitance. Measured with reference to ground.

#### $C_D$ , $C_S$ (On)

On switch capacitance. Measured with reference to ground.

 $C_{\text{IN}}$ 

Digital input capacitance.

ton

Delay time between the 50% and 90% points of the digital input and switch on condition.

#### toff

Delay time between the 50% and 90% points of the digital input and switch off condition.

#### **t**<sub>BBM</sub>

On or off time measured between the 80% points of both switches when switching from one to another.

#### **Charge Injection**

Measure of the glitch impulse transferred from the digital input to the analog output during on/off switching.

#### **Off Isolation**

Measure of unwanted signal coupling through an off switch.

#### Crosstalk

Measure of unwanted signal that is coupled from one channel to another as a result of parasitic capacitance.

#### -3 dB Bandwidth

Frequency at which the output is attenuated by 3 dB.

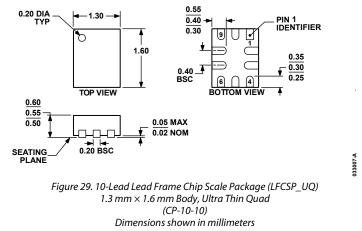
#### Insertion Loss

The loss due to the on resistance of the switch.

#### THD + N

Ratio of the harmonics amplitude plus noise of a signal to the fundamental.

# **OUTLINE DIMENSIONS**



#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
ADG824BCPZ-REEL <sup>1</sup>	-40°C to +85°C	10-Lead Mini Lead Frame Chip Scale Package (LFCSP_UQ)	CP-10-10	А
ADG824BCPZ-REEL7 <sup>1</sup>	–40°C to +85°C	10-Lead Mini Lead Frame Chip Scale Package (LFCSP_UQ)	CP-10-10	А
EVAL-ADG824EBZ <sup>1</sup>	–40°C to +85°C	Evaluation Board		

<sup>1</sup> Z = RoHS Compliant Part.

# NOTES

# NOTES

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